

RL201G THRU RL207G

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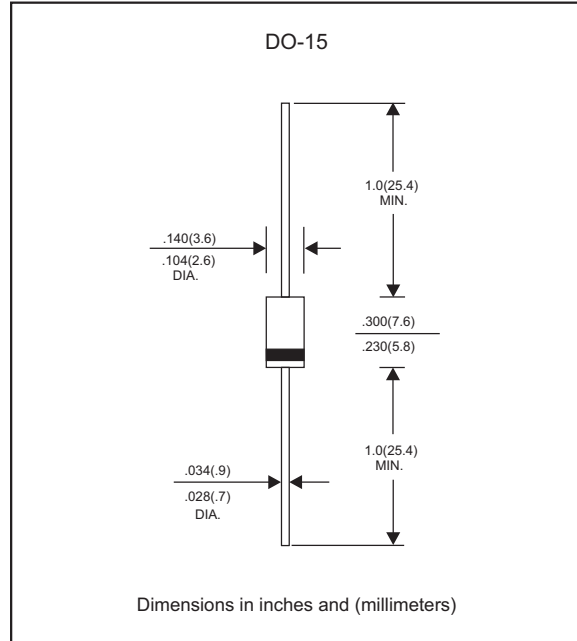
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**RL201G THRU RL207G****2.0A Axial Leaded General Purpose Rectifiers 50V-1000V****Features**

- Axial lead type devices for through hole design
- High current capability
- High surge capability
- Glass passivation junction chip inside
- Lead free parts meet RoHS requirements
- Suffix "-H" indicates Halogen-free parts, ex. RL201G-H

**Mechanical data**

- Epoxy : UL94-V0 rated flame retardant
- Case : Molded plastic, DO-15
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position : Any
- Weight : Approximated 0.40 gram

**Package outline****Maximum ratings and Electrical characteristics** (AT  $T_A=25^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                  | CONDITIONS                                        | Symbol          | MIN. | TYP. | MAX. | UNIT                 |
|----------------------------|---------------------------------------------------|-----------------|------|------|------|----------------------|
| Forward rectified current  | See Fig.1                                         | $I_O$           |      |      | 2.0  | A                    |
| Forward surge current      | 8.3ms single half sine-wave (JEDEC methode)       | $I_{FSM}$       |      |      | 70   | A                    |
| Reverse current            | $V_R = V_{RRM} \quad T_J = 25^{\circ}\text{C}$    | $I_R$           |      |      | 5.0  | $\mu\text{A}$        |
|                            | $V_R = V_{RRM} \quad T_J = 125^{\circ}\text{C}$   |                 |      |      | 50   |                      |
| Thermal resistance         | Junction to ambient                               | $R_{\theta JA}$ |      | 40   |      | $^{\circ}\text{C/W}$ |
| Diode junction capacitance | $f=1\text{MHz}$ and applied 4V DC reverse voltage | $C_J$           |      | 20   |      | pF                   |
| Storage temperature        |                                                   | $T_{STG}$       | -65  |      | +175 | $^{\circ}\text{C}$   |

| SYMBOLS | $V_{RRM}^{*1}$<br>(V) | $V_{RMS}^{*2}$<br>(V) | $V_R^{*3}$<br>(V) | $V_F^{*4}$<br>(V) | Operating temperature<br>$T_J, (^{\circ}\text{C})$ |
|---------|-----------------------|-----------------------|-------------------|-------------------|----------------------------------------------------|
| RL201G  | 50                    | 35                    | 50                | 1.10              | -55 to +150                                        |
| RL202G  | 100                   | 70                    | 100               |                   |                                                    |
| RL203G  | 200                   | 140                   | 200               |                   |                                                    |
| RL204G  | 400                   | 280                   | 400               |                   |                                                    |
| RL205G  | 600                   | 420                   | 600               |                   |                                                    |
| RL206G  | 800                   | 560                   | 800               |                   |                                                    |
| RL207G  | 1000                  | 700                   | 1000              |                   |                                                    |

\*1 Repetitive peak reverse voltage

\*2 RMS voltage

\*3 Continuous reverse voltage

\*4 Maximum forward voltage@ $I_F=2.0\text{A}$

## Rating and characteristic curves (RL201G THRU RL207G)

FIG.1-TYPICAL FORWARD CHARACTERISTICS

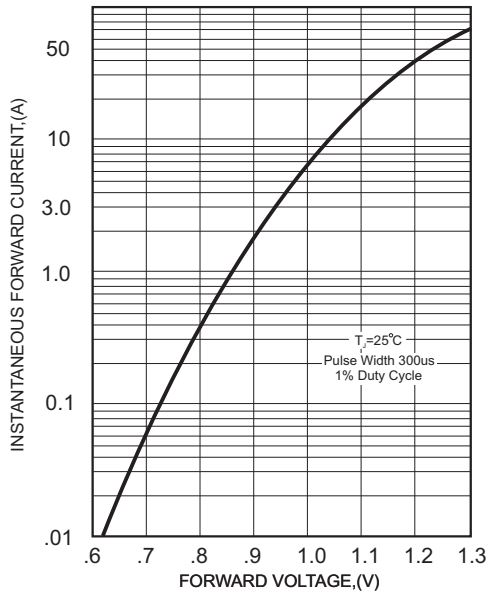


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

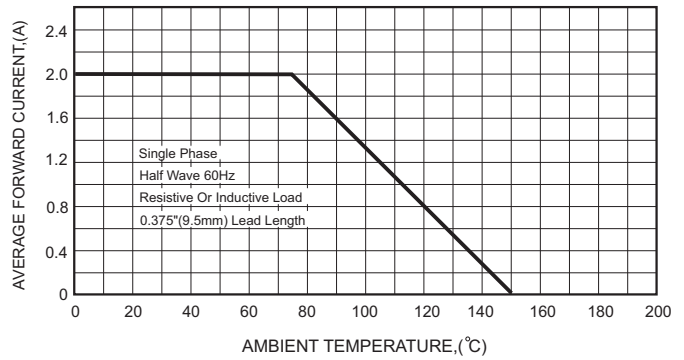


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

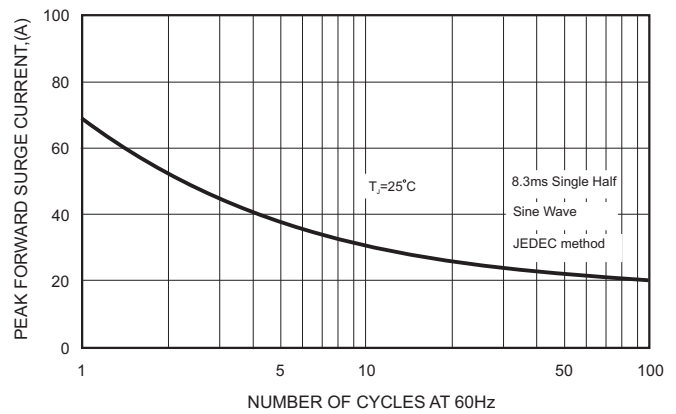


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

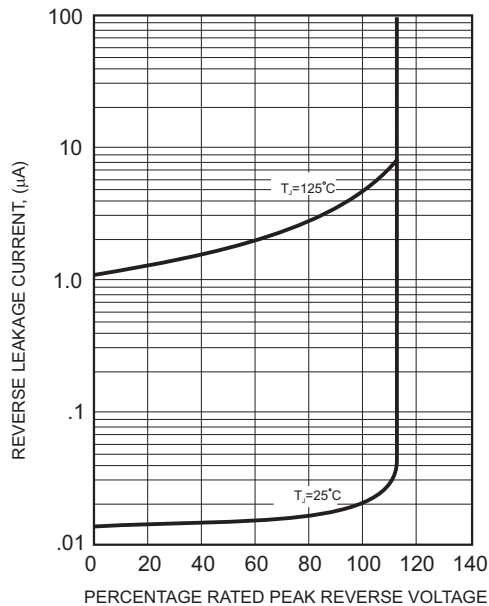
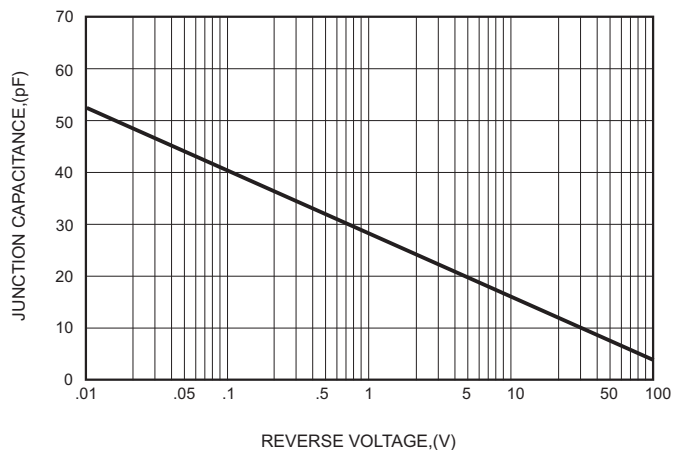


FIG.5-TYPICAL JUNCTION CAPACITANCE



# RL201G THRU RL207G

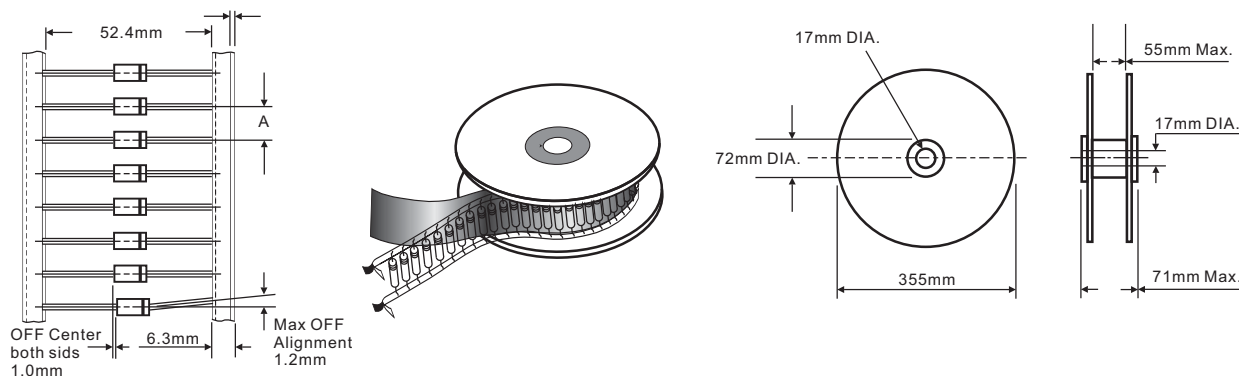
## Pinning information

| Pin                        | Simplified outline                                                                     | Symbol                                                                                  |
|----------------------------|----------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|
| Pin1 cathode<br>Pin2 anode | 1  2 | 1  2 |

## Marking

| Type number | Marking code |
|-------------|--------------|
| RL201G      | RL201G       |
| RL202G      | RL202G       |
| RL203G      | RL203G       |
| RL204G      | RL204G       |
| RL205G      | RL205G       |
| RL206G      | RL206G       |
| RL207G      | RL207G       |

## Taping & bulk specifications for AXIAL devices



## REEL PACKING

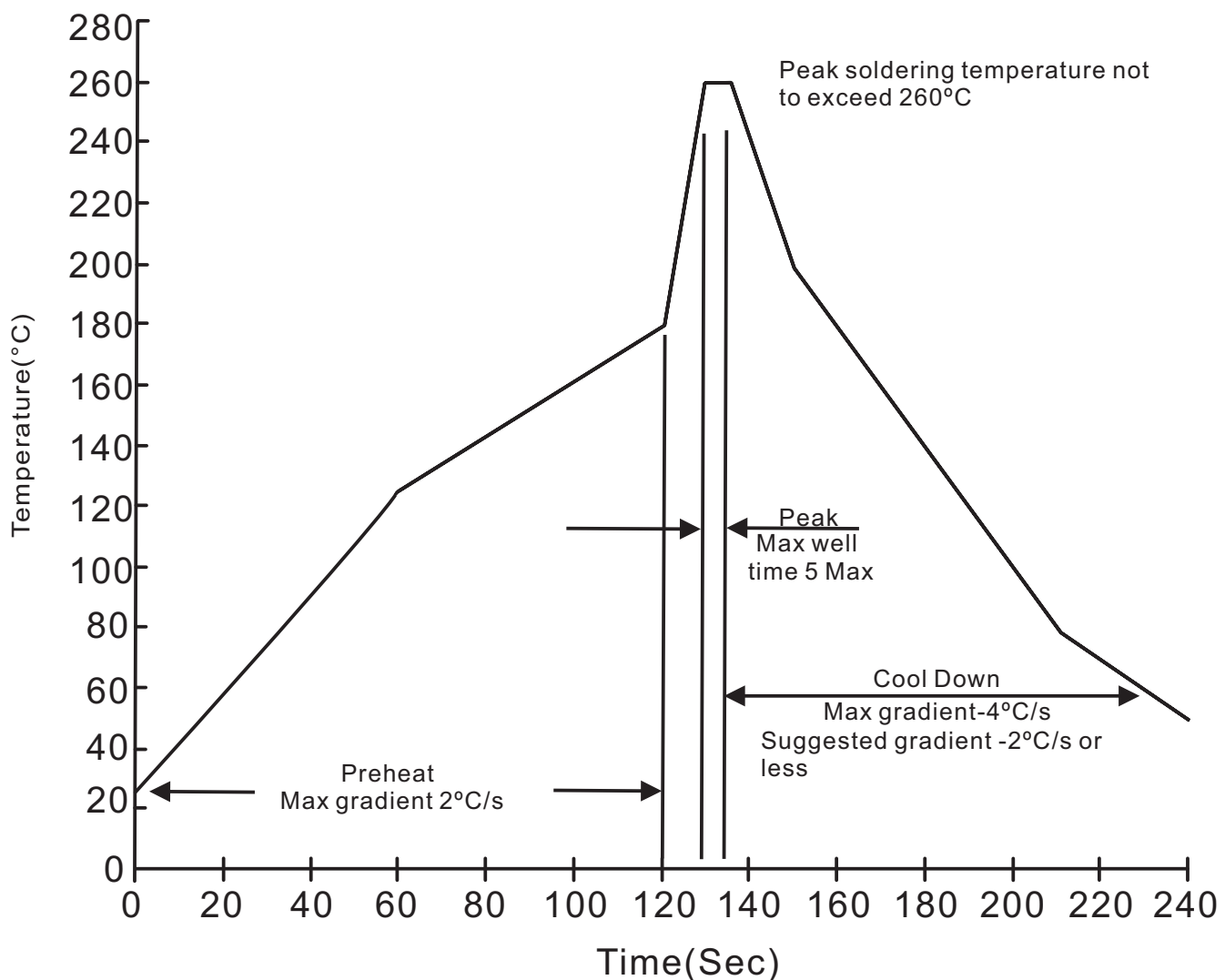
| DEVICE CASE TYPE | Q'TY 1 (PCS / REEL) | COMPONENT SPACING "A" in FIG. A | CARTON SIZE (m/m) | Q'TY 2 (PCS / CARTON) | APPROX. CROSS WEIGHT(kg) |
|------------------|---------------------|---------------------------------|-------------------|-----------------------|--------------------------|
| DO-15            | 4,000               | 5 mm                            | 360 * 340 * 370   | 16,000                | 9.9                      |

## AMMO PACKING

| DEVICE CASE TYPE | Q'TY 1 (PCS / BOX) | INNER BOX SIZE (m/m) | CARTON SIZE (m/m) | Q'TY 2 (PCS / CARTON) | APPROX. CROSS WEIGHT(kg) |
|------------------|--------------------|----------------------|-------------------|-----------------------|--------------------------|
| DO-15            | 3,000              | 260 * 83 * 160       | 440 * 270 * 340   | 30,000                | 14.3                     |

**RL201G THRU RL207G****BULK PACKING**

| DEVICE<br>CASE<br>TYPE | Q'TY 1<br>(PCS / BOX) | INNER<br>BOX SIZE<br>(m/m) | CARTON<br>SIZE<br>(m/m) | Q'TY 2<br>(PCS / CARTON) | APPROX.<br>CROSS<br>WEIGHT(kg) |
|------------------------|-----------------------|----------------------------|-------------------------|--------------------------|--------------------------------|
| DO-15                  | 500                   | 194 * 84 * 20              | 465 * 220 * 260         | 25,000                   | 12.9                           |

**Suggested thermal profiles for soldering processes****1. Lead free temperature profile wave-soldering**

**RL201G THRU RL207G****High reliability test capabilities**

| Item Test                         | Conditions                                                                                                                               | Reference                     |
|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|
| 1. Solder Resistance              | at $260 \pm 5^\circ\text{C}$ for $10 \pm 2$ sec.<br>immerse body into solder $1/16'' \pm 1/32''$                                         | MIL-STD-750D<br>METHOD-2031   |
| 2. Solderability                  | at $245 \pm 5^\circ\text{C}$ for 5 sec.                                                                                                  | MIL-STD-202F<br>METHOD-208    |
| 3. Pull Test                      | 1.0kg in axial lead direction for 10 sec.<br>$I_F = I_O$                                                                                 | MIL-STD-202F<br>METHOD-211A   |
| 4. Bend Lead                      | 1.0kg weight applied to each lead bending<br>arc $90^\circ \pm 5^\circ$ for 3 times                                                      | MIL-STD-202F<br>METHOD-211A   |
| 5. High Temperature Reverse Bias  | $V_R = 80\%$ rate at $T_J = 150^\circ\text{C}$ for 168 hrs.                                                                              | MIL-STD-750D<br>METHOD-1038   |
| 6. Forward Operation Life         | Rated average rectifier current at $T_A = 25^\circ\text{C}$ for 500hrs.                                                                  | MIL-STD-750D<br>METHOD-1027   |
| 7. Intermittent Operation Life    | $T_A = 25^\circ\text{C}$ , $I_F = I_O$<br>On state: power on for 5 min.<br>off state: power off for 5 min,<br>on and off for 500 cycles. | MIL-STD-750D<br>METHOD-1036   |
| 8. Pressure Cooker                | $15P_{SIG}$ at $T_A = 121^\circ\text{C}$ for 4 hrs.                                                                                      | JESD22-A102                   |
| 9. Temperature Cycling            | $-55^\circ\text{C}$ to $+125^\circ\text{C}$ dwelled for 30 min.<br>and transferred for 5min. total 10 cycles.                            | MIL-STD-750D<br>METHOD-1051   |
| 10. Forward Surge                 | 8.3ms single half sine-wave , one surge.                                                                                                 | MIL-STD-750D<br>METHOD-4066-2 |
| 11. Humidity                      | at $T_A = 85^\circ\text{C}$ , RH=85% for 1000hrs.                                                                                        | MIL-STD-750D<br>METHOD-1021   |
| 12. High Temperature Storage Life | at $175^\circ\text{C}$ for 1000 hrs.                                                                                                     | MIL-STD-750D<br>METHOD-1031   |